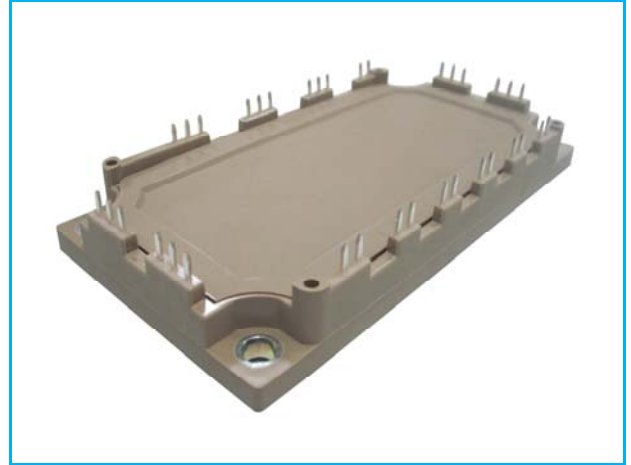


## PRODUCT FEATURES

- IGBT<sup>3</sup> Chip(Trench+Field Stop technology)
- High short circuit capability,self limiting short circuit current
- Low saturation voltage and positive temperature coefficient
- Fast switching and short tail current
- Free wheeling diodes with fast and soft reverse recovery
- Industry standard package with insulated copper base plate and soldering pins for PCB mounting
- Temperature sense included



## APPLICATIONS

- AC motor control
- Motion/servo control
- Inverter and power supplies

### IGBT-inverter

ABSOLUTE MAXIMUM RATINGS( $T_C=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter/Test Conditions	Values	Unit
$V_{CES}$	Collector Emitter Voltage	$T_J=25^\circ\text{C}$	V
$V_{GES}$	Gate Emitter Voltage		
$I_C$	DC Collector Current	$T_C=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	A
		$T_C=60^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	
$I_{CM}$	Repetitive Peak Collector Current	$t_p=1\text{ms}$	400
$P_{tot}$	Power Dissipation Per IGBT	$T_C=25^\circ\text{C}, T_{Jmax}=175^\circ\text{C}$	600

### Diode-inverter

ABSOLUTE MAXIMUM RATINGS ( $T_C=25^\circ\text{C}$  unless otherwise specified)

Symbol	Parameter/Test Conditions	Values	Unit
$V_{RRM}$	Repetitive Reverse Voltage	$T_J=25^\circ\text{C}$	V
$I_{F(AV)}$	Average Forward Current		A
$I_{FRM}$	Repetitive Peak Forward Current	$t_p=1\text{ms}$	
$I^2t$		$T_J=125^\circ\text{C}, t=10\text{ms}, V_R=0\text{V}$	A <sup>2</sup> S

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## MMG200W060X6EN

### IGBT-inverter

#### ELECTRICAL CHARACTERISTICS ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_{GE(th)}$	Gate Emitter Threshold Voltage	$V_{CE}=V_{GE}, I_C=3.2\text{mA}$	4.9	5.8	6.5	V
$V_{CE(sat)}$	Collector Emitter Saturation Voltage	$I_C=200\text{A}, V_{GE}=15\text{V}, T_J=25^\circ\text{C}$		1.45	1.9	
		$I_C=200\text{A}, V_{GE}=15\text{V}, T_J=125^\circ\text{C}$		1.6		
$I_{CES}$	Collector Leakage Current	$V_{CE}=600\text{V}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$			1	mA
		$V_{CE}=600\text{V}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$			5	mA
$I_{GES}$	Gate Leakage Current	$V_{CE}=0\text{V}, V_{GE}=\pm 15\text{V}, T_J=25^\circ\text{C}$	-400		400	nA
$R_{gint}$	Integrated Gate Resistor			2		$\Omega$
$Q_g$	Gate Charge	$V_{CE}=300\text{V}, I_C=200\text{A}, V_{GE}=\pm 15\text{V}$		2.15		$\mu\text{C}$
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$		13		nF
$C_{res}$	Reverse Transfer Capacitance			0.38		nF
$t_{d(on)}$	Turn on Delay Time	$V_{CC}=300\text{V}, I_C=200\text{A}$ $R_G=2.0\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		150	ns
			$T_J=125^\circ\text{C}$		160	ns
$t_r$	Rise Time	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		30	ns
			$T_J=125^\circ\text{C}$		40	ns
$t_{d(off)}$	Turn off Delay Time	$V_{CC}=300\text{V}, I_C=200\text{A}$ $R_G=2.0\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		340	ns
			$T_J=125^\circ\text{C}$		370	ns
$t_f$	Fall Time	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		60	ns
			$T_J=125^\circ\text{C}$		70	ns
$E_{on}$	Turn on Energy	$V_{CC}=300\text{V}, I_C=200\text{A}$ $R_G=2.0\Omega,$ $V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		1	mJ
			$T_J=125^\circ\text{C}$		1.55	mJ
$E_{off}$	Turn off Energy	$V_{GE}=\pm 15\text{V},$ Inductive Load	$T_J=25^\circ\text{C}$		5.65	mJ
			$T_J=125^\circ\text{C}$		6.9	mJ
$I_{SC}$	Short Circuit Current	$t_{psc} \leq 6\mu\text{s}, V_{GE}=15\text{V}$ $T_J=125^\circ\text{C}, V_{CC}=360\text{V}$		1000		A
$R_{thJC}$	Junction to Case Thermal Resistance ( Per IGBT )				0.25	K/W

### Diode-inverter

#### ELECTRICAL CHARACTERISTICS ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions		Min.	Typ.	Max.	Unit
$V_F$	Forward Voltage	$I_F=200\text{A}, V_{GE}=0\text{V}, T_J=25^\circ\text{C}$		1.55	1.95	V
		$I_F=200\text{A}, V_{GE}=0\text{V}, T_J=125^\circ\text{C}$		1.50		
$t_{rr}$	Reverse Recovery Time	$I_F=200\text{A}, V_R=300\text{V}$ $di_F/dt=-5700\text{A}/\mu\text{s}$ $T_J=125^\circ\text{C}$		170		ns
$I_{RRM}$	Max. Reverse Recovery Current			230		A
$Q_{RR}$	Reverse Recovery Charge			17		$\mu\text{C}$
$E_{rec}$	Reverse Recovery Energy			5.2		mJ
$R_{thJCD}$	Junction to Case Thermal Resistance ( Per Diode )				0.45	K/W

# MMG200W060X6EN

## NTC CHARACTERISTICS ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Min.	Typ.	Max.	Unit
$R_{25}$	Resistance $T_C = 25^\circ\text{C}$		5		$\text{K}\Omega$
$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15 \text{ K}))]$		3375		K

## MODULE CHARACTERISTICS ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter/Test Conditions	Values	Unit	
$T_{Jmax}$	Max. Junction Temperature	175	$^\circ\text{C}$	
$T_{Jop}$	Operating Temperature	-40~150		
$T_{stg}$	Storage Temperature	-40~125		
$V_{isol}$	Isolation Breakdown Voltage	AC, 50Hz(R.M.S), t=1minute	3000	V
CTI	Comparative Tracking Index		>200	
Md	Mounting Torque	Recommended (M5)	2.5~5	Nm
Weight			300	g

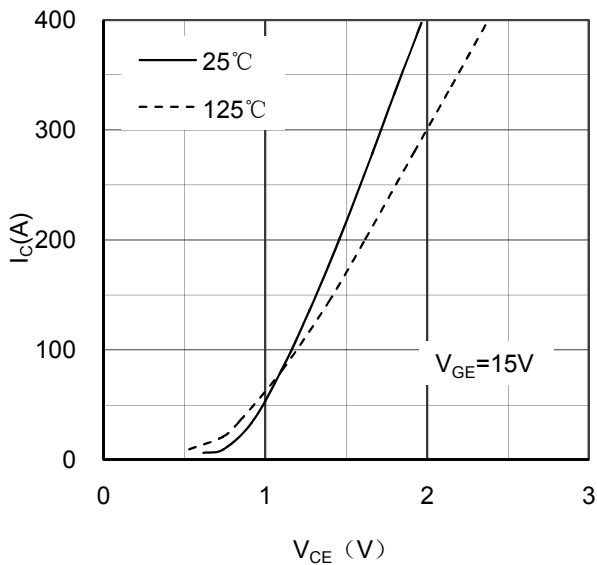


Figure 1. Typical Output Characteristics IGBT-inverter

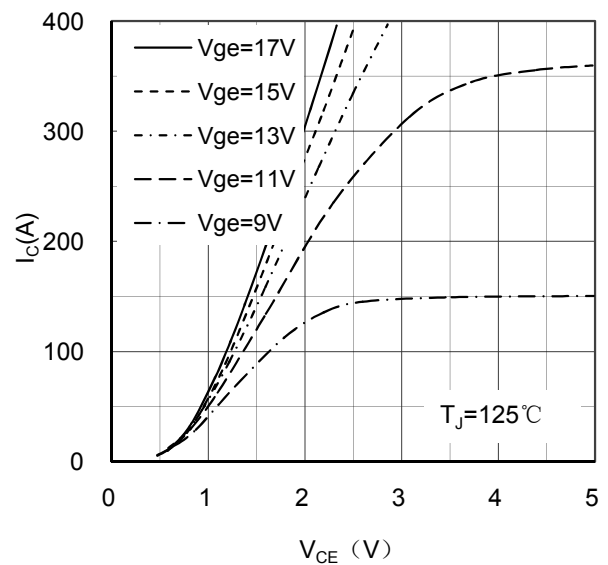


Figure 2. Typical Output Characteristics IGBT-inverter

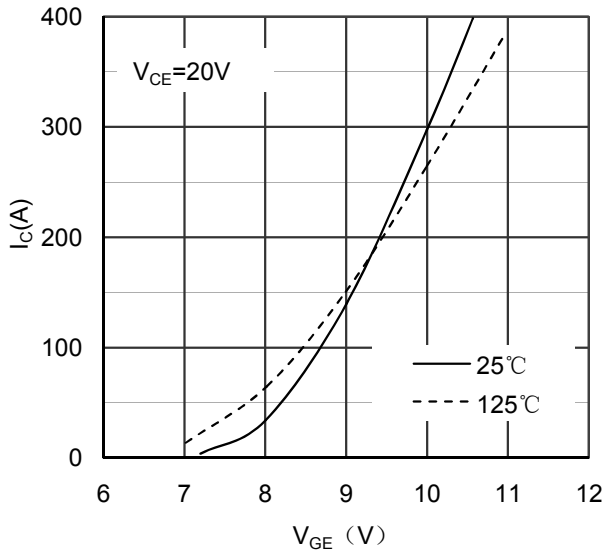


Figure 3. Typical Transfer characteristics IGBT-inverter

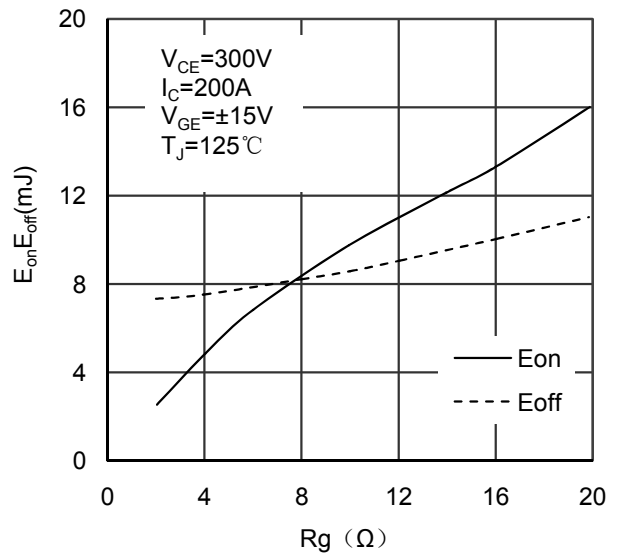


Figure 4. Switching Energy vs Gate Resistor IGBT-inverter

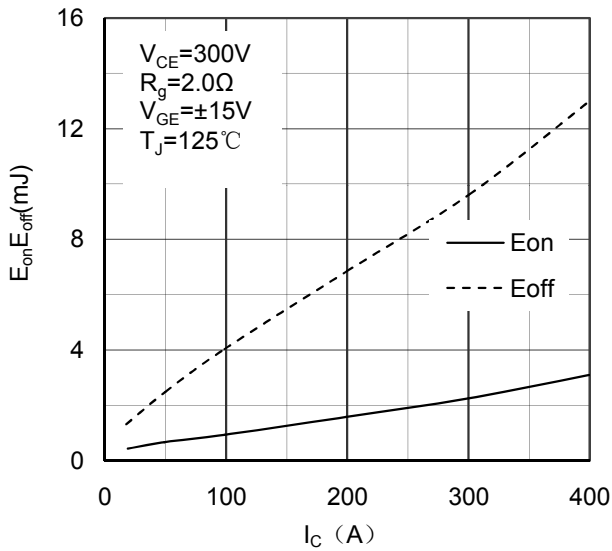


Figure 5. Switching Energy vs Collector Current IGBT-inverter

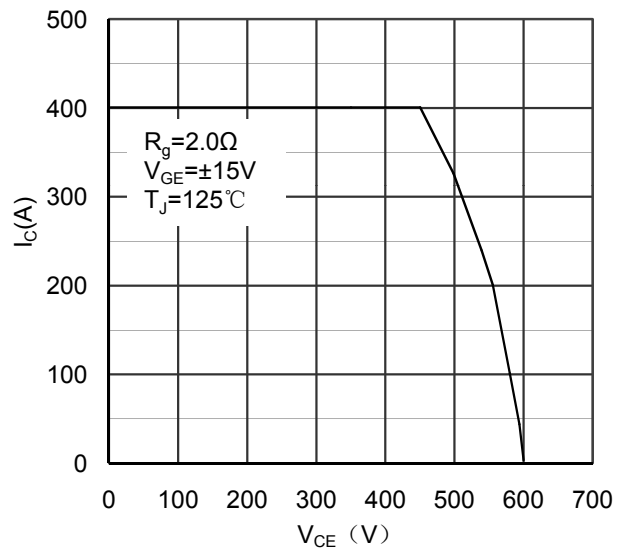


Figure 6. Reverse Biased Safe Operating Area IGBT-inverter

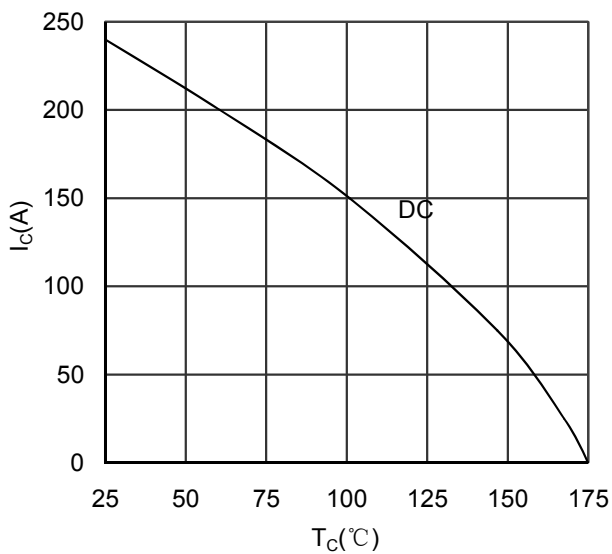


Figure 7. Collector Current vs Case temperature IGBT-inverter

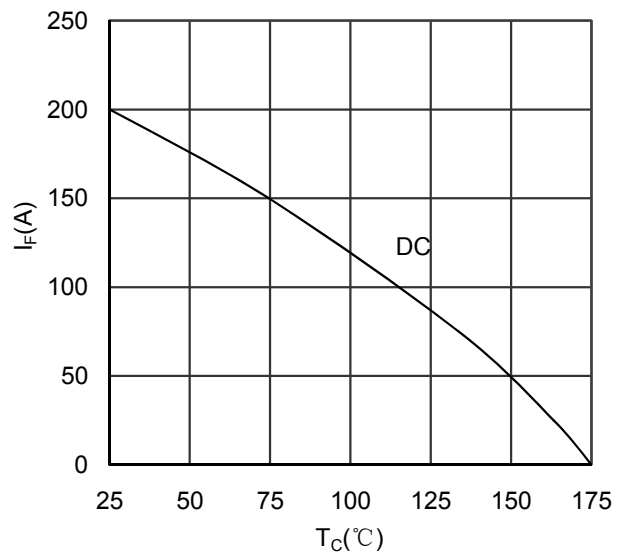


Figure 8. Forward current vs Case temperature Diode-inverter

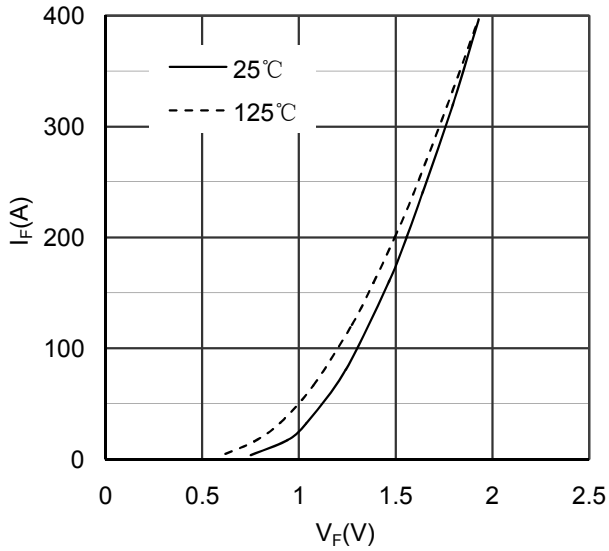


Figure 9. Diode Forward Characteristics Diode -inverter

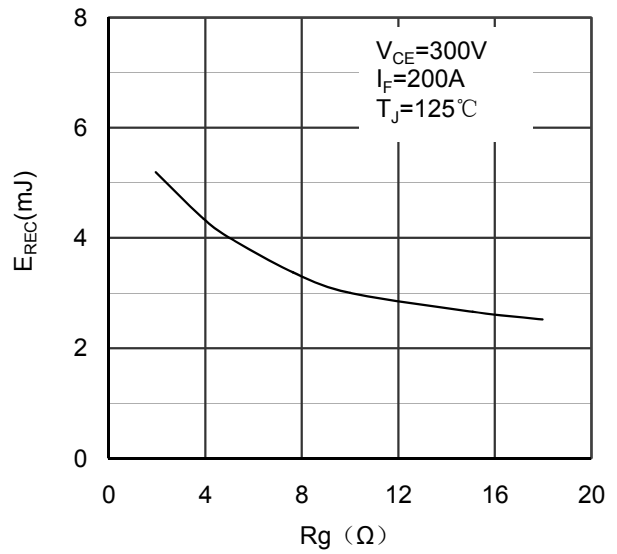


Figure 10. Switching Energy vs Gate Resistor Diode - inverter

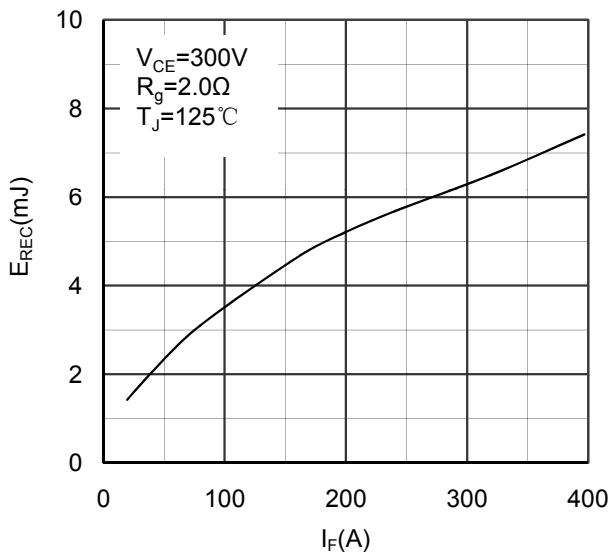


Figure 11. Switching Energy vs Forward Current Diode-inverter

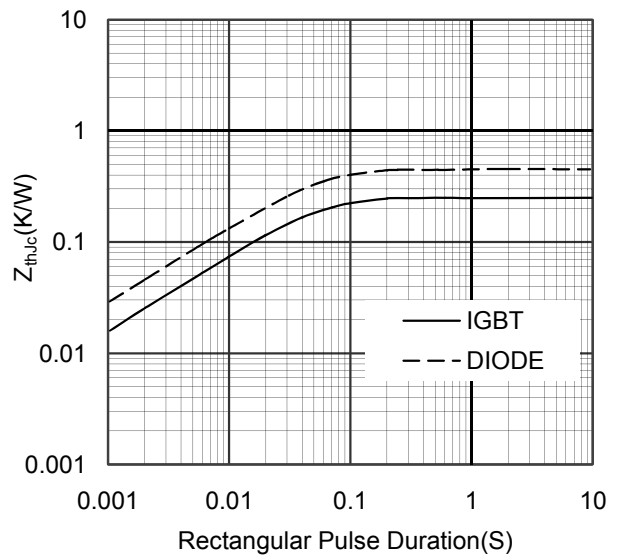


Figure 12. Transient Thermal Impedance of Diode and IGBT-inverter

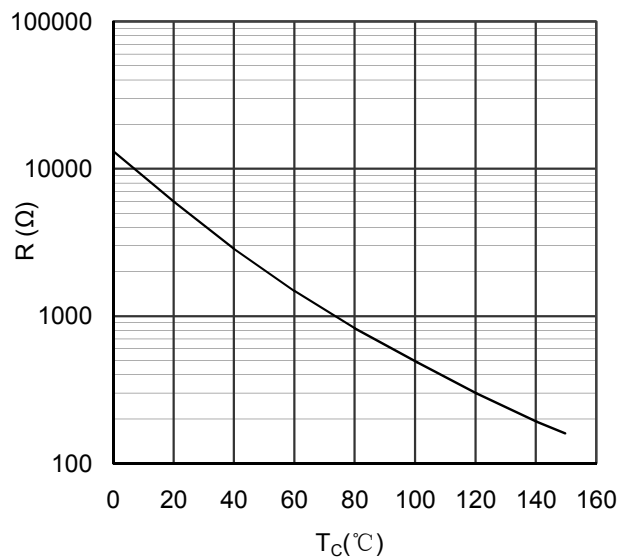


Figure 13. NTC Characteristics

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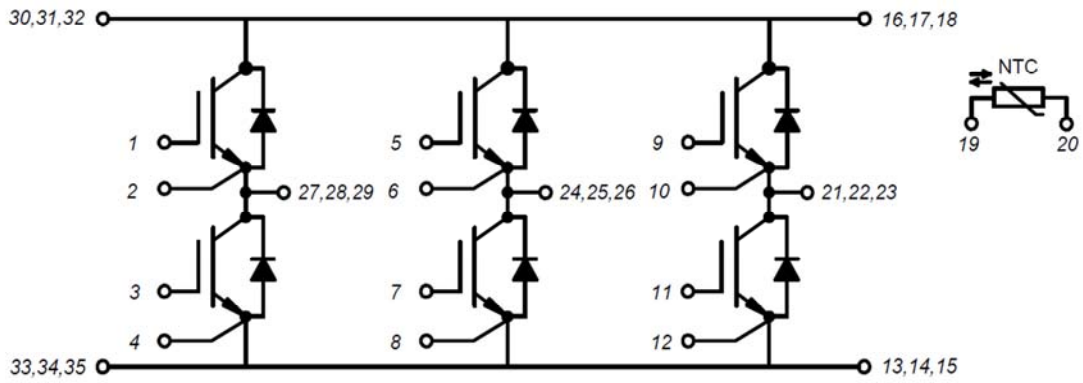
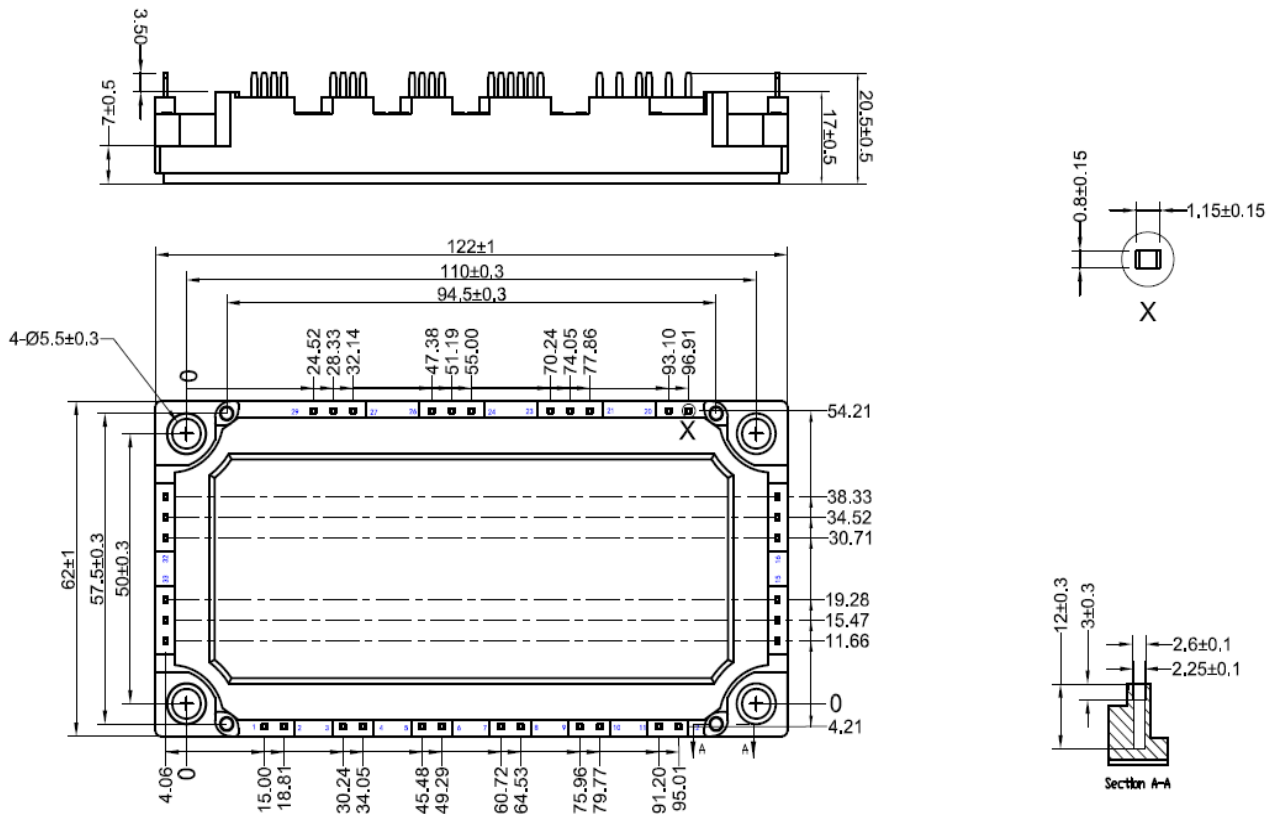


Figure 14. Circuit Diagram



Dimensions in (mm)

Figure 15. Package Outline